Read / Write amplifier for FDD BH6626FS

The BH6626FS is a read / write IC designed for floppy disk drives and has an internal active filter for memory systems in which saddle margins are important. Any of multiple write current settings can be selected, and both density switching and inner track / outer track switching are done internally.

Applications

Floppy disc drives (1MB and 2MB)

Features

- 1) Active filter switched internally.
- Time domain filter with internal switch set according to transfer rate.
- Density switching and inner track / outer track switching are done internally.

● Absolute maximum ratings (unless otherwise noted, Ta = 25°C)

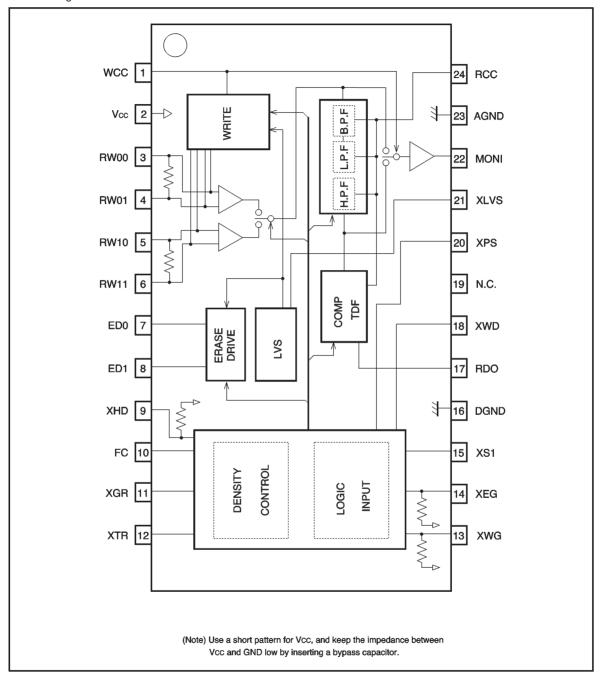
Parameter	Symbol	Limits	Unit
Power supply voltage	Vcc	+7	V
Operating temperature	Topr	0~+70	℃
Storage temperature	Tstg	−55∼+125	°C
Digital input voltage	VI	-0.5∼Vcc+0.3	٧
RW pin voltage	VRW	+15	٧
LVS output voltage	VLVS	Vcc+0.3	٧
ED pin voltage	VER	Vcc+0.3	V
Power dissipation	Pd	650*	mW

^{*} Reduced by 6.5mW for each increase in Ta of 1°C over 25°C.

Recommended operating conditions

Parameter	Symbol	Min.	Тур.	Max.	Unit
Power supply voltage	Vcc	4.5	5.0	5.5	V

Block diagram



●Pin descriptions and Input / output circuits

Pin No.	Pin name	Equivalent circuit	Function
1	wcc	Vcc The state of t	For connecting the write current adjustmen resistor Connect the write current adjustment resistor between this pin and Vcc Setting this pin to the low level during reading switches MONI to differentiator output
2	Vcc		Power supply pin
3	RW00	4 6 3 5	Active when SIDE0 and the read/write head connecting pin (pin 15, XS1) is at the high level (side 0)
4	RW01	W. T. W. W. W. T. W.	Starts at RW00 during the start of writing (from reading to writing)
5	RW10		Active when the read / write head connecting pin (pin 15, XS1) is at the low level (side 1)
6	RW11		Starts at RW10 during the start of writing (from reading to writing)
7	ED0	V _∞ 7 8	Side 0 erase current sink
8	ED1	***************************************	Side 1 erase current sink

Pin No.	Pin name	Equivalent circuit	Function
9	XHD	Vcc	1 MB / 2 MB selector High = 1 MB Low = 2 MB
10	FC	Voc	Option 2 selector Selector signal high level = active
11	XGR	10 11 12	Option mode selector Controls the write current
12	XTR		Inner edge / outer track position setting Controls the filter and write current
13	XWG	Vcc 30k 30k	Write enable gate (Schmidt input) Low = active
14	XEG	Vcc \$100k	Erase enable gate (Schmidt input) Low = active
15	XS1	Vcc 30k	Head / side switching signal Low = active (Schmidt input) High = side 0, low = side 1

Pin No.	Pin name	Equivalent circuit	Function
16	DGND		Digital ground
17	RDO	Vcc	Read data output TTL high level = active
18	XWD	Vcc	Write data input Operates at falling edge (Schmidt input)
19	N.C.		
20	XPS	Vcc 30k 20 7777	Power save selector Low level = active

Pin No.	Pin name	Equivalent circuit	Function
21	XLVS	21	External low level voltage detection pin Open collector output when low level voltage is detected Switches to low level when Vcc drops below the specified voltage
22	MONI	Vcc 250 \$ 222	Preamplifier output and differentiator output monitoring Monitor is switched with pin 1 (WCC)
23	AGND		Analog ground
24	RCC	V _{CC} V _{CC} 24	Filter (LPF,BPF) cutoff frequency and TDF 1st M/M pulse width setting resistor connection

●Electrical characteristics (unless otherwise noted, Ta = 25°C, Vcc = 5V)

Supply current

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Current dissipation, Standby	ICCST	_	190	400	μΑ	*1
Current dissipation,Read	ICCR	_	28	40	mA	*1
Current dissipation,Write	ICCW	_	8.5	15	mA	*2

^{*1} RRCC=2.0 [kΩ] (XHD=H)

^{*2} RWCC=2.4 [kΩ] (When 2MB inner edge, XGR=high level, excluding IWR and IER)

Low level voltage detection circuit

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
-	VTH1+	_	4.05	4.3	V	When supply volt. rises, int. LVS = write protect
Threshold voltage 1	VTH1-	3.6	3.85	4.1	V	When supply volt. falls, int. LVS = write protect
	VTH2+	_	3.92	4.17	V	When supply volt. rises, ext. LVS
Threshold voltage 2	VTH2-	3.47	3.72	3.97	V	When supply volt. falls, ext. LVS
Hysteresis voltage	VH	50	_	_	mV	
Output low level voltage	VOL	_	_	0.40	V	Vcc=2.5 [V] IOL=0.2 [mA]
Output leakage current	IOH	_	_	10	μΑ	

Recovery time

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
POWER · SAVE→READ	TR2	_	_	500	μs	by XPS
READ→ERASE	TR3	_	_	6	μs	by XEG
READ→WRITE	TR4	_	_	4	μs	by XWG
WRITE→READ	TR5E	_	_	20	μs	by XEG
WHITE-READ	TR5W	_	_	160	μS	by XWG
SIDE0↔SIDE1	TR6	_	_	40	μS	by XS1
1MB↔2MB	TR7	_	_	40	μs	by XHD

Preamplifier

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Voltage gain(1)	GVD1	43	46	49	dB	f=125[kHz], VIN=2.5[mV _{P-P}] (differential) (OPTION outer edge)
Voltage gain(2)	GVD2	46	49	52	dB	f=125[kHz], VIN=2.5[mV _{P-P}] (differential) (1 MB/2 MB outer edge, OPTION inner edge
Voltage gain(3)	GVD3	49	52	56	dB	f=125[kHz], VIN=1.5[mV _{P-P}] (differential) (1 MB/2 MB inner edge)
SIDE0↔SIDE1 crosstalk	GCTLK	50	_	_	dB	f=125[kHz], VIN=100[mV _{P-P}] (differential)*3
Differential input resistance	RID	_	4	-	kΩ	Input resistance = 8.0 k Ω parallel, damping resistance = 8.0 k Ω
Input conversion noise voltage	VN	-	2.5	3.7	μVrms	f=500[Hz]~1[MHz]
Input sink current	ISINK	_	180	-	μΑ	
Differential input voltage amplitude(1)	VIN1	_	_	5.0	mV _{P-P}	5% distortion (sine wave input) (OPTION outer edge)
Differential input voltage amplitude(2)	VIN2	_	_	3.5	mV _{P-P}	5% distortion (sine wave input) (1 MB/2 MB outer edge, OPTION inner edge)
Differential input voltage amplitude(3)	VIN3	_	_	2.0	mV _{P-P}	5% distortion (sine wave input) (1 MB/2 MB = inner edge)
Common mode rejection ratio	CMRR	50	_	_	dB	f=125[kHz], VIN=100[mVP-P] *3
Power supply rejection ratio	PSRR	40	_	_	dB	f=250[kHz], VIN=100[mV _{P-P}] *3

Preamplifier / L.P.F / differentiator (B.P.F)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Filter time constant accuracy	EFIL	-10	_	+10	%	*3
Total gain (preamplifier/ LPF/differentiator) (1)	GVDD1	41.0	45.0	49.0	dB	f=250[kHz], VIN=2.5[mV _{P-P}] (differential) (2MB outer edge)
Total gain (preamplifier/ LPF/differentiator) (2)	GVDD2	44.0	48.0	52.0	dB	f=250[kHz], VIN=2.5[mV _{P-P}] (differential) (inner edge)
Total gain (preamplifier/ LPF/differentiator) (3)	GVDD3	40.5	44.5	48.5	dB	f=250[kHz], VIN=2.5[mV _{P-P}] (differential) (OPTION 2 outer edge)
Differentiator output peaking frequency setting range	fo	0.1	_	0.5	MHz	Defined according to typical value in the settings

*3 RRCC=2.0 [$k\Omega$] (XHD=L, XTR=H, FC=L)

Comparator and waveform shaping

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
TDF M/M pulse width accuracy (1)	TDF1	-10	_	+10	%	1MB (TYP: 2545[ns]) f=62.5[kHz]~125[kHz] *4
TDF M/M pulse width accuracy (2)	TDF2	-10	_	+10	%	2MB, OPTION (TYP: 1280[ns]) f=62.5[kHz]~125[kHz] *4
RD pulse width	TRD	270	400	530	ns	Determination level: 1.5[V]
Rise time	TTLH	_	_	70	ns	Rise time between 0.4[V]and 2.0[V]
Fall time	TTHL	-	_	70	ns	Fall time between 2.0 [V] and 0.4[V]
Peak shift	P. S.	_	_	1.0	%	f=250[kHz], VIN=1[mV _{P-P}](differential)
Output low level voltage	VOL	_	_	0.5	V	
Output high level voltage	VOH	2.7	_	_	٧	Level after 70[ns]rise from 0.4[V]

*4 RRCC=2.0 [kΩ]

Write circuit

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Write current adjustment range	IWR	2.0	_	20	mA0-P	
Write current accuracy	ACIW	-7.0	_	+7.0	%	*5
Write current pairability	△IWR	-1.0	_	+1.0	%	RWCC=2.4[kΩ]
Write current supply voltage dependency	PSIW	-4.0	-0.8	+3.0	%/V	RWCC=2.4[kΩ]
Output saturation voltage	VSATRW	_	0.4	1.0	V	IWR=12[mA]
0"	ILKRW1	_	_	20	μΑ	Unselected side
Off-state leakage current	ILKRW2	_	_	50	μΑ	Selected side
Minimum write data pulse width	TWD	70	_	_	ns	
Write current switching ratio accuracy	ACIWTR	±10× (1- setting ratio)		%	*6	

^{*5} RWCC=2.4 $[k\Omega]$, adapted for desired setting. *6 Error in setting ratio (reference: 1MB outer track)

Erase output

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	
Erase current adjustment	IER	_	_	40	mA		
Output saturation voltage	VSATER	_	0.2	0.6	V	IER=40[mA]	
Output leak current	IOH	_	_	10	μΑ	Off, ED0 = ED1 = Vcc	

Logic input

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions		
Input high level voltage	VIH	2.0	_	_	V			
Input low level voltage	VIL	_	_	0.8	V			
Input voltage hysteresis	VH	0.15	_	_	V	Applies to XWD, XWG, XEG, XS1		
Input low level current	IIL1	_	50	100	μΑ	Vcc=5[V] VIL=GND Applies to XWG, XEG ,XHD		

■Mode table

	Mode	e	1MB		21	ИB	OPTION1		OPTION2	
	Transfer	rate	250[kbps]		500[H	dbps]	500[kbps]		500[kbps]	
Input		XHD	HIGH		LC	DW .	HIGH		NO CARE	
	Mode	FC	LOW		LC	DW .	LOW		HIGH	
		XGR	HIGH		NO (CARE	LOW			
	Track	XTR (XSWF)	Outer track LOW	Inner track HIGH						
Output	Preamplifier gain [dB]		49	52	49	52	46	49	46	49
	Filter	fo [kHz]	197	210	378	415	350	400	350	
	riitei	Characteristic.(Q)*1 A A		Α	Α	В	С	Α	С	
	TDF	[nSEC]	25	545	12	180	1280			
	Write current switching ratio		wcc	WCC ×0.733	WCC ×0.433	WCC ×0.318	wcc	WCC ×0.733		CC .733

(However, RRCC=2.0 [kΩ])

Total filter peak frequency setting

 $f_0 = a / (RRCC [k\Omega] + 0.09) [kHz]$

a = 412 1M outer track

439 1M inner track

790 2M outer track

867 2M inner track

732 outer track(with OPTION 1), OPTION 2

836 inner track (with OPTION 1)

TDF time constant setting

250 [kbps] : T = 939 × RRCC [kΩ] +667 [ns] 500 [kbps] : T = 403 × RRCC [kΩ] +474 [ns]

Write current setting

$$Iwr = \frac{24.0}{RWCC [k\Omega]} [mA]$$

- (However, Till 100—2.0 [K2]
- * 1 (A) Butterworth characteristics
 - (B) Chebyshev characteristics
 - (C) Refer to Option characteristics, filter characteristics

●Filter characteristic

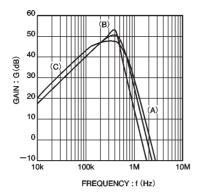
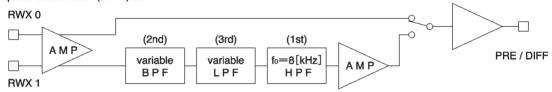
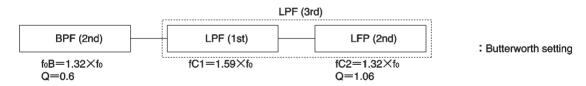


Fig. 1 Pre in / diff out characteristic

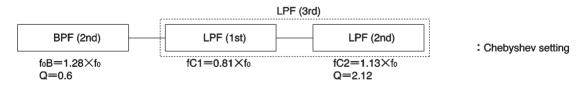
Preamplifier-differentiator (B.P.F)-L.P.F



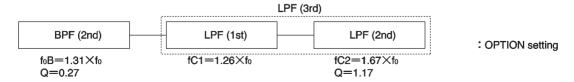
(A) Total characteristic peak frequency (fo): 1 MB, 2 MB outer track OPTION inner edge



(B) Total characteristic peak frequency (fo): 2 MB inner track



(C) Total characteristic peak frequency (fo): OPTION outer track, OPTION2



Measurement circuit

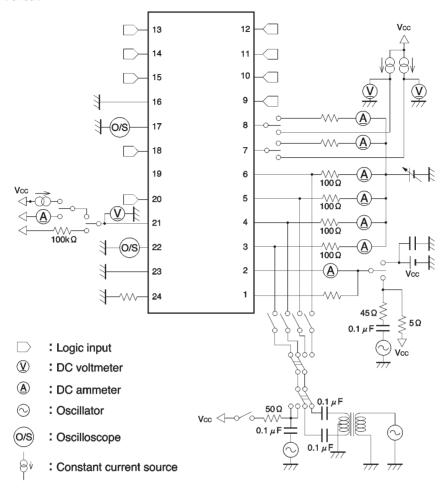


Fig. 2

Circuit operation

(1) Read

The input signal from the head coils from each side of the disc is amplified by the preamplifier and then differentiated. The filter time constant can be set externally. After differentiation, the differential output is input to the comparator. The time domain filter detects zero cross, and the output is converted to read data. The monostable multivibrator width can be set externally, while the read data pulse width is a constant 400ns.

(2) Write

Input write data are converted to toggle movements by

the internal flip-flops, operating the write driver. The write driver current is supplied by the write current generator, but the externally set current can be controlled according to density and by selecting inner track/ outer track.

(3) Erase

An open collector output pin is used, and the erase current is set with a resistor between it and the head.

(4) Power supply

When the low level voltage detector detects a drop in the supply voltage, writing and erasing are prohibited.

Operation notes

- (1) Use a short pattern for Vcc, and a sufficiently wide AGND and DGND. Keep the impedance between Vcc and GND low by inserting a bypass capacitor.
- (2) Use a pattern that will minimize interference between digital signals and the head.

Electrical characteristic curves

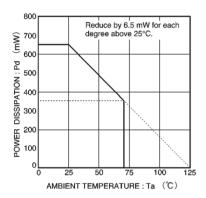


Fig. 3 Thermal derating characteristics

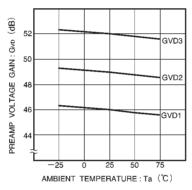


Fig. 4 Preamp voltage gain vs. ambient temperature

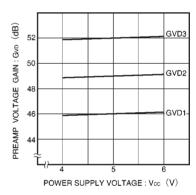


Fig. 5 Preamp voltage gain vs. power supply voltage

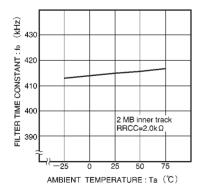


Fig. 6 Filter time constant (fo) vs. ambient temperature

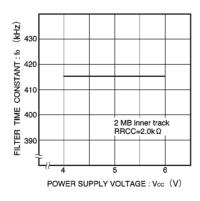


Fig. 7 Filter time constant (fo) vs. power supply voltage

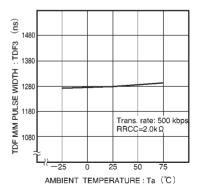
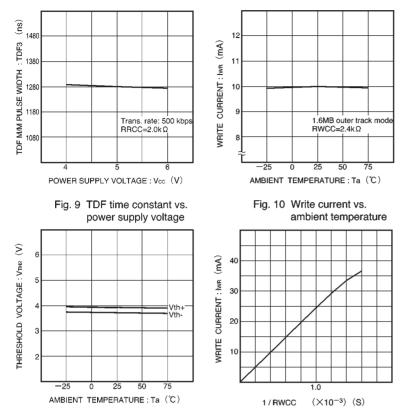


Fig. 8 TDF time constant vs. ambient temperature



12 10 9 1.6MB outer track mode RWCC=2.4kΩ

POWER SUPPLY VOLTAGE: Voc (V)

Fig. 11 Write current and power supply voltage

Fig. 12 Low level detection voltage vs. ambient temperature

External dimensions (Units: mm)

Fig. 13 Write current vs. write current adjustment resistance

10.0±0.2 24 13 13 14 13 14 13 14 13 14 10 11 10 14 10 10

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